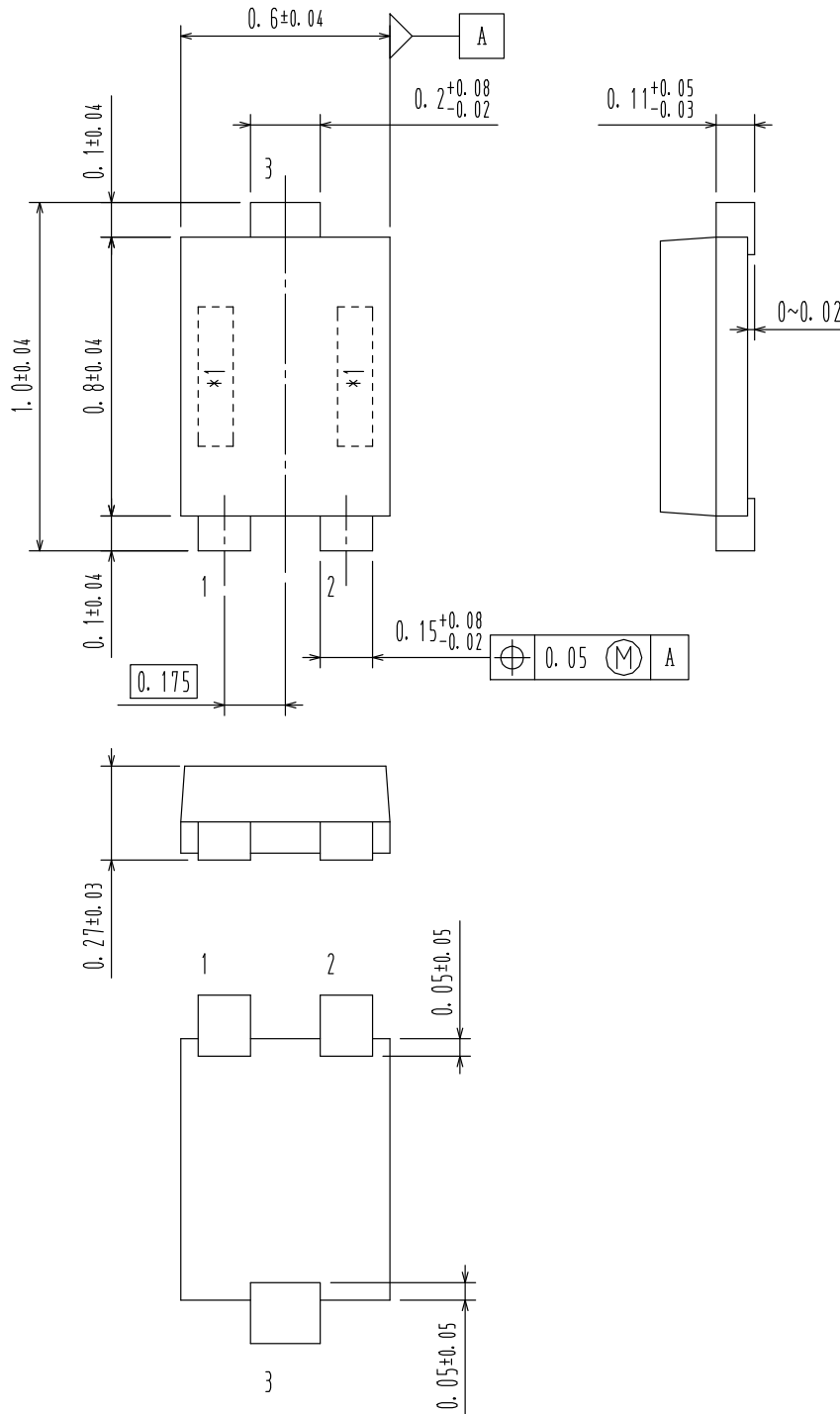



MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS

SOT-1123 / USFP
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